U.S. DEPARTMENT OF COMMERCE ark Office -2-07-008

To the Commissioner For Patents: Please recoa

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f.

_	Name of conveying party(ies):	2. Name and address of receiving party(ies):
2 1 1	Rabindra N. Das, Kostas I. Papathomas, Voya R. Markovich	Name: Endicott Interconnect Technologies, Inc.
1	Additional names of conveying party(ies) attached?	Street Address: 1701 North Street
4	Yes X No	City: Endicott 5
	3. Nature of Conveyance	State: New York Zip 13760
	Tr A · · · ·	8
1	Assignment Merger Security Agreement Change of Name	Additional name(s) & address(es) attached?
	Other	YesX No
	Execution Date: 05/10/07	
	4. Application number(s) or patent number(s): Title: CIRCUITIZED SUBSTRATE WITH CONDUCT CIRCUITIZED SUBSTRATE AND METHOD O If this document is being filed together with a new application, A. Patent Application No(s). Additional numbers attached? Yes X No	, the execution date of the application is
	5. Name and address of party to whom correspondence concerning document should be mailed: Hinman, Howard & Kattell, LLP 700 Security Mutual Building 80 Exchange Street Binghamton, New York 13901 Att: Lawrence R. Fraley	6. Total number of applications and patents involved: 1 7. Total fee (37 CVF 3.41): X Enclosed \$40.00
9/20 C:80	007 DBYRNE 00000125 11802434 021 40.00 DP	
	DO NOT USE THIS SPACE	
	8. Statement and signature To the best of my knowledge and belief, the foregoing information	n is true and correct and any attached copy is a true copy of the
	original document.	In Den
	Lawrence R. Fraley	haley 05/10/07
	original document.	10/10/07 Date

		TH 2 07 000		
Wherea	ASSIGNMENT	EI-2-07-008		
(1)	Rabindra N. Das	City of Vestal		
(-)	County of Broome	And State of New York		
	•			
(2)	Kostas I. Papathomas	City of Endicott And State of New York		
	County of Broome	And State of New Fork		
(3)	Voya R. Markovich	City of Endwell		
(5)	County of Broome	And State of New York		
	•			
have in	evented certain improvements in CIRCUITIZED	SUBSTRATE WITH CONDUCTIVE PASTE,		
ELECTRICAL ASSEMBLY INCLUDING SAID CIRCUITIZED SUBSTRATE AND METHOD OF				
MAKING SAID SUBSTRATE and have executed, respectively, a United States patent application therefor on				
HICICIO	•			
5/	(1) 5/10/07, (2) 5/10	07, (3) 1/10/07		
	And whereas, ENDICOTT INTERCONNECT	TECHNOLOGIES, INC., a corporation of		
New Y	ork, having a place of business at Endicott, New			
acquire	e the entire right, title and interest in the said app	lication and invention, and to any United States		
and for	reign patents to be obtained therefor;			
	No. 11 Com Com control to a maid anation ma	e sint whereaf is hereby asknowledged, we the		
Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we the above named hereby sell, assign, and transfer to EI, its successors and assigns, the entire right, title and				
interest in the said application and invention therein disclosed for protection in the United States and				
foreign countries, and all rights of priority resulting from the filing of said United States application,				
and we request the Commissioner of Patents to issue any Letters Patent granted upon the invention set				
forth in said application to EI, its successors and assigns; and we hereby agree that EI may apply for				
foreign Letters Patent on said invention and we will execute all papers necessary in connection with the				
United States and foreign applications when called upon to do so by EI.				
Signed	l: _			
	(1) at Endicott, New York, this 10 day or	f May, 2007.		
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	Ku	Rabindra N. Das		
	(2) at Endicott, New York, this day o	.i \		
	(2) at Endicott, New York, this 0 day o	f Moy, 2007.		
		1 1 2 1 4		
		Hostay I. Paparliaman		
		Kostas I. Papathomas		
(3) at Endicott, New York, this 10 day of, 2007.				
(5) at Endicott, 140W Tork, tills 10 day of 17000000000000000000000000000000000000				
	<u> </u>	nockonsk		
		Voya R. Markovich		

RECORDED: 05/23/2007

PATENT REEL: 019364 FRAME: 0845